

Color Camera Module

Version 0.10 May, 2014

1 Cover Page and Summary of Specification

	Progressive scan CMOS imag				
Image sensor	Number of total pixels (H) x(V)	1,952 x 1,236, 2.41 M [pixels]			
	Number of effective pixels (H) x(V)	1,944 x 1,224, 2.38 M [pixels]			
	Number of recommended recording pixels (H) x(V)	1,920 x 1,080	0000		
	Focal length	4.9 [mm] to 94 [mm]	Tool Service		
,	Magnification	20 [times]			
Lens	Horizontal angle of view	59.5[degree] (Wide) 3.3[degree] (Tele)	Outline Inves		
	F value	F1.6 (Wide) to F3.5 (Tele)	Outline Image		
	Zoom motor	Stepping motor			
Control	Focus motor	Stepping motor			
mechanics	Iris	Meter Galvano method			
	IRCF	Meter Galvano method			
Output mode	HD	1080p/60,1080p/59.94,1080p/50,1080i/60,1080i/59.94,1080i/50,1 080p/30,1080p/29.97, 1080p/25,720p/60,720p/59.94, 720p/50,720p/30, 720p/29.97, 720p/25			
	SD	NTSC, PAL *NOT standard format			
Synchronized	Progressive	Comparable to SMPTE 274 M, 296 M			
codes	Interlace	Comparable to SMPTE 274 M			
L/O pins	Image signal I/O	HD Digital (LVDS) SD Analog VBS			
I/O pins	Control signal I/O	VISCA protocol (CMOS 5 [V])			
	Power supply	DC 6.0 [V] to DC 12.0 [V]			
	Power consumption	2.4W (Typ. DC IN 6-12V, Lens actua Wide Dynamic Range Off)	·		
	Storage temperature	-20 to +60 [degree] / 20 [%] to 95 [% Absolute humidity: 36 [g/m3]]		
Power, others	Operating temperature	-5 to +60 [degree] / 20 [%] to 80 [%] Absolute humidity: 36 [g/m3]			
	Dimensions (W) x (L) x (H)	50 [mm] x 60 [mm] x 88 [mm]			
	Mass	270 [g]			

Sony reserves the right to change products and specifications without prior notice. This information does not convey any license by any implication or otherwise under any patents or other right. Application circuits shown, if any, are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits.

Sony CONFIDENTIAL Sony Corporation. DIG VSS



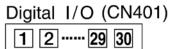
2 Function

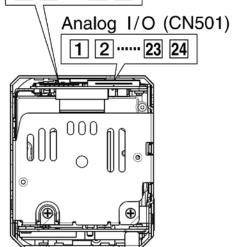
Exposure	Full Auto / Gain Limit Setting / Shutter Priority / Iris Priority / Manual / Bright		
White Balance	Auto White Balance / ATW / Indoor / Outdoor / One Push WB / Manual WB / Outdoor Auto / Sodium Vapor Lamp Auto / Sodium Vapor Lamp / Sodium Vapor Lamp Outdoor Auto		
Focus	Auto Focus / Manual Focus Mode / One Push Trigger Mode / Infinity Mode / Near Limit Mode		
Wide Dynamic Range	Yes		
Visibility Enhancer	Yes		
Noise Reduction	3D / 2D Noise Reduction		
ICR (Day and Night)	Yes		
Image Stabilizer	No		
Slow AE	Yes		
High Sensitivity	Yes		
Gamma	Standard / Straight gamma		
D-ZOOM	12x		
Character Gen.	Yes		
Defog	Yes		
Color Enhancement	Yes		
Picture Effect	Neg. Art / Black & White		
Spherical Privacy Zone Masking	Yes		
E-Flip	Yes		
HLC	Yes		



3 Connection Specification

3.1 Connector and Pin Assignment





CN401 Kel.Co. USL00-30L-C

Pin No.	Name	Level
1	TXOUT3+	
2	TXOUT3-	
3	TXCLKOUT+	
4	TXCLKOUT-	
5	TXOUT2+	
6	TXOUT2-	
7	TXOUT1+	
8	TXOUT1-	
9	TXOUT0+	
10	TXOUT0-	
11	GND	
12	TxD	CMOS 5[V](Low:Max0.1[V],High;Min4.4[V])
13	RxD	CMOS 5[V](Low:Max1.0[V],High;Min2.3[V])
14	DC IN	6 to 12[V] DC
15	DC IN	6 to 12[V] DC
16	DC IN	6 to 12[V] DC
17	DC IN	6 to 12[V] DC
18	DC IN	6 to 12[V] DC
19	GND	
20	GND	
21	TXOUT7+	Single out mode: open
22	TXOUT7-	Single out mode: open
23	TXOUT6+	Single out mode: open
24	TXOUT6-	Single out mode: open
25	NC	
26	RESET	Reset:Low(GND),Normal:Open(1.8[V])
27	TXOUT5+	Single out mode: open
28	TXOUT5-	Single out mode: open
29	TXOUT4+	Single out mode: open
30	TXOUT4-	Single out mode: open

CN501 Kyocera-elco 046240024006800+

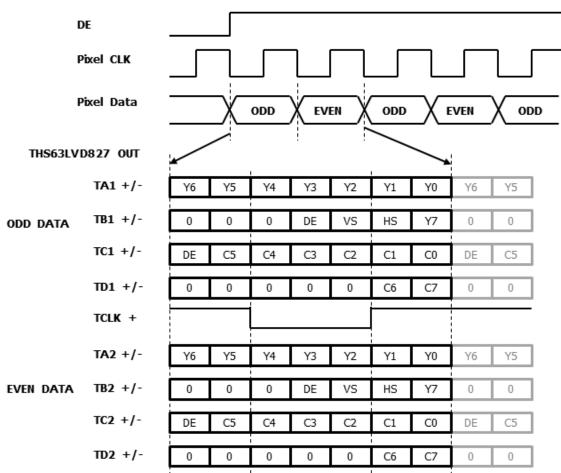
Pin No.	Name	Level
1	GND	
2	TxD	CMOS 5[V](Low:Max0.1[V],High;Min4.4[V])
3	RxD	CMOS 5[V](Low:Max1.0[V],High;Min2.3[V])
4	RESET	Reset:Low(GND),Normal:Open(1.8[V])
5	GND	
6	NC	
7	GND	
8	NC	
9	GND	
10	VBS-OUT	
11	GND	
12	NC	
13	GND	
14	NC	
15	GND	
16	NC	
17	GND	
18	DC IN	6 to 12[V] DC
19	DC IN	6 to 12[V] DC
20	DC IN	6 to 12[V] DC
21	DC IN	6 to 12[V] DC
22	GND	
23	DC IN	6 to 12[V] DC
24	GND	



3.2 LVDS PIXEL DATA FORMAT

3.2.1 DUAL MODE

THS63LVD827 IN

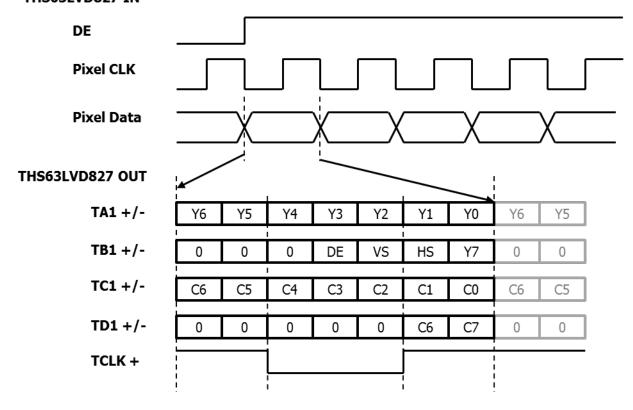


Output Format	Pixel CLK[Hz)	TCLK+[Hz]
1080p/60	148.5M	74.25M
1080p/59.94	148.5M/1.001	74.25M/1.001
1080p/50	148.5M	74.25M
1080i/60	74.25M	37.125M
1080i/59.94	74.25M/1.001	37.125M/1.001
1080i/50	74.25M	37.125M
1080p/30	74.25M	37.125M
1080p/29.97	74.25M/1.001	37.125M/1.001
1080p/25	74.25M	37.125M
720p/60	74.25M	37.125M
720p/59.94	74.25M/1.001	37.125M/1.001
720p/50	74.25M	37.125M
720p/30	74.25M	37.125M
720p/29.97	74.25M/1.001	37.125M/1.001
720p/25	74.25M	37.125M



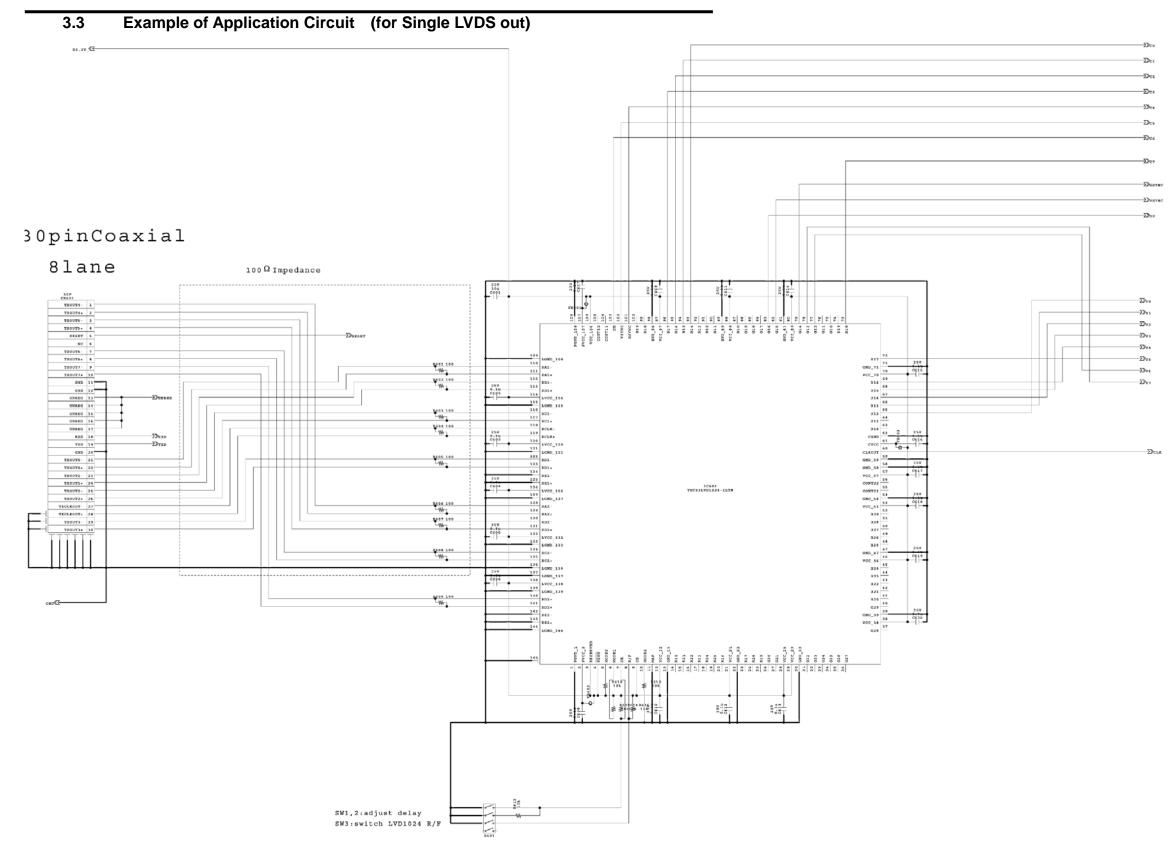
3.2.2 SINGLE MODE

THS63LVD827 IN



Output Format	Pixel CLK[Hz]	TCLK+[Hz]
1080p/60	148.5M	148.5M
1080p/59.94	148.5M/1.001	148.5M/1.001
1080p/50	148.5M	148.5M
1080i/60	74.25M	74.25M
1080i/59.94	74.25M/1.001	74.25M/1.001
1080i/50	74.25M	74.25M
1080p/30	74.25M	74.25M
1080p/29.97	74.25M/1.001	74.25M/1.001
1080p/25	74.25M	74.25M
720p/60	74.25M	74.25M
720p/59.94	74.25M/1.001	74.25M/1.001
720p/50	74.25M	74.25M
720p/30	74.25M	74.25M
720p/29.97	74.25M/1.001	74.25M/1.001
720p/25	74.25M	74.25M





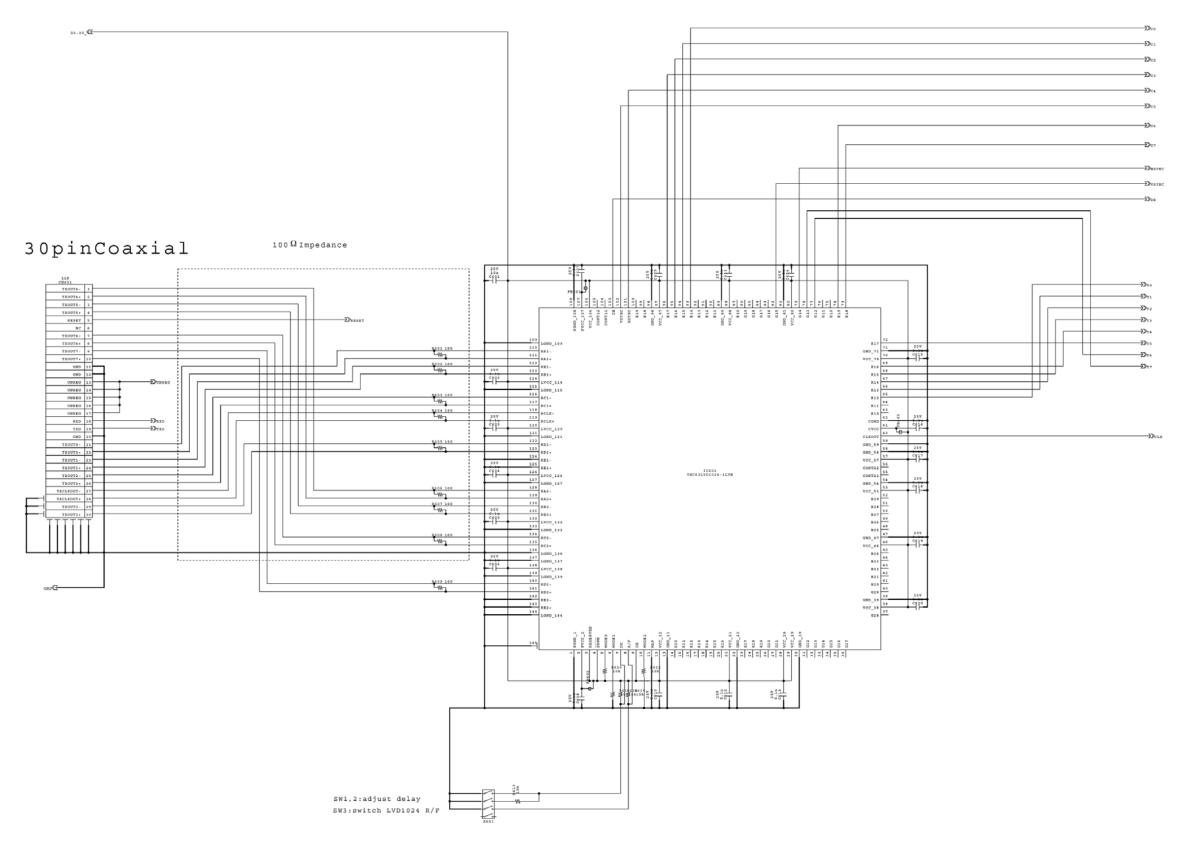
The application circuit is a typical example illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of this circuit.

6

Sony CONFIDENTIAL Sony Corporation. DIG VSS



3.4 Example of Application Circuit (for Dual LVDS out)



The application circuit is a typical example illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of this circuit.

Sony CONFIDENTIAL Sony Corporation. DIG VSS 7

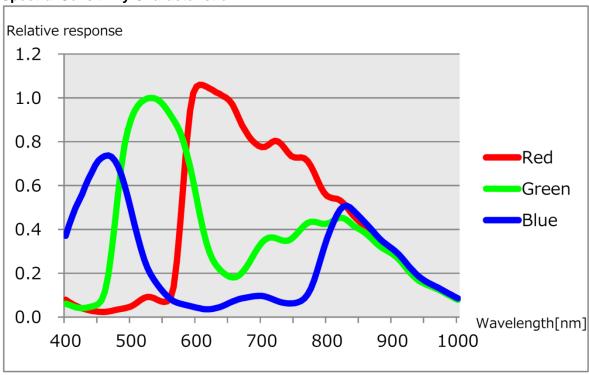


4 Detailed Specifications

4.1 Sensor Specifications

Image sensor	Progressive scan CMOS image sensor		
Chip size (H) x (V)	8.5 [mm] x 7.3 [mm] (Type 1/2.8)		
Unit cell size (H) x (V)	2.8 [um] x 2.8 [um]		
Number of total pixels (H) x (V)	1,952 x 1,236 2.41 M [pixels]		
Number of effective pixels (H) x (V)	1,944 x 1,224 2.38 M [pixels]		
Scan method	Progressive scan		
Color filter	Primary color Bayer arrangement		
Shutter	Rolling shutter (NOT Global shutter)		

Spectral Sensitivity Characteristic



4.2 Lens Specifications (*Design Specifications)

Configuration		9 groups, 11 elements		
	Horizontal	59.5 [degrees] *1(Wide) 3.3 [degrees] *1 (Tele)		
Angle of view	Vertical	35.7 [degrees] *1(Wide) 1.8 [degrees] *1(Tele)		
	Diagonal	66.5 [degrees] *1(Wide) 3.8 [degrees] *1(Tele)		
Fnumber		1.6 (Wide) to 3.5 (Tele)		
Focal length (35 [mm] converted)		4.7 [mm] to 94 [mm] (33.0 [mm] to 659 [mm])		
TV distortion		-2.0 [%] (Wide) / +1.0 [%] (Tele) at infinity *2		
Focal range		10 [mm] to infinity (Wide) 1,000 [mm] to infinity (Tele)		

Note) *1 The above values of field of view are calculated based on the maximum recording pixel area of image sensor. They differ from the ones on 2D outline drawing, which are calculated based on the effective pixel area of image sensor and include the margin for the assembly tolerance. Distortion Correction ON

*2 Distortion Correction OFF



4.3 Camera Specifications

- S/N

45 [dB] (White 50 [%], AE mode "Auto") 69[dB] (Black, Gain 0 [step])

- Minimum Illumination

50 [IRE], ICR OFF, IRIS OPEN, AGC MAX(28 [step])

Typ.value

	30[fps] mode	60[fps] mode
Hi Sens Off	0.4 [lx]	0.8 [lx]
Hi Sens ON	0.1 [lx]	0.2 [lx]

White Balance

AWB (Auto White Balance) mode 2500[k] – 7500[k] ATW (Auto Tracing White Balance) mode 2000[k] – 10000[k]

- Camera Horizontal Level

When setting up the camera and object horizontally, screen should be ± 3 [°] of the horizontal line of the monitor.

Optical Axis Gap

When zooming from Tele end to Wide end, the gap of screen center object on Tele end is in radius circle of 8% or less of short side of monitor screen.

Image Vibration

2 [mm] or less on 21[inch] monitor. during Tele to Wide moved

- Dirt and Scratch Specifications

[Conditions]

- 1. Zoom: Wide end, Focus: ∞
- 2. Aperture: F4 fixed
- 3. Light viewer (500 to $1000 \text{ [cd/m}^2\text{]}$)

Image on full screen

1. Density sample: LEE FILTERS 130 CLEAR

Resolution

(WIDE)

Center 900 [TV lines] or more Corners 800 [TV lines] or more

(TELE)

Center 700 [TV lines] or more Corners 600 [TV lines] or more

TV Distortion (Distortion Correct ON)

±2[%]

Vibration Correction Frequency

3 to 13 [Hz]



4.4 Absolute Maximum supply voltage

Item	Signal	Min.	Typ.	Max.	Unit
Supply voltage	DC IN*	-0.5	-	13.2	[V]

^{*}FCB input terminal part

4.5 Operating Conditions

Item	Signal	Min.	Тур.	Max.	Unit
Supply voltage	DC IN*	6.0	9.0	12.0	[V]

^{*}FCB input terminal part

4.6 Power Consumption

(Measured conditions: Room temperature, typical voltage, high speed frame rate mode as stable operation)

Item	Signal	Min	Ave	Max	Unit
Power Supply	DC IN 9.0 [V]	-	2.4	2.9	[W]
	DC IN 6.0 [V]	-	2.4	2.9	
	DC IN 12.0 [V]	-	2.5	3.0	

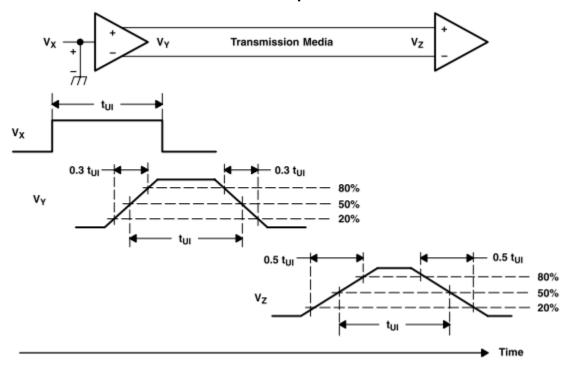
4.7 Lens Durability

(At Room temperature)



5 Electrical Characteristics

5.1 AC Characteristics of LVDS Output Part



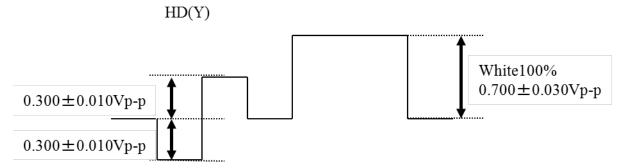
• Data: 74.25 x7 MHz

DC characteristics of VISCA I/F part

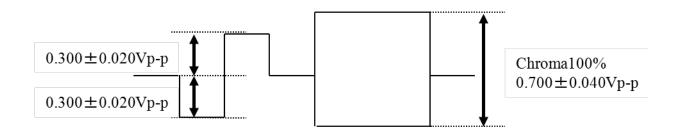
5.2 VISCA (CMOS (5V))



5.3 Analog Video



HD(PbPr)



5.4 MTBF

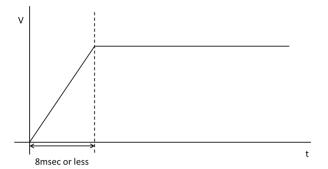
Approx. 6.0 [years]

5.5 Environmental Test (Under the Condition of 10 Cartons)

Drop test: Sony Technical Manual (STM-1059 level3)

5.6 Power Supply Condition

8 [msec] or less



SONY FCB-EV7310

6 Handling Precautions

6.1 Operating Temperature

Make sure that the temperature inside the equipment does not exceed the recommended operating temperature

6.2 Durability of the Image Sensor

The on-chip color filter of the sensor may be decolorized if a large amount of light enters into the sensor. Such conditions of use should be avoided as no product warranty is given for de-colorization. Be sure to take protective measurements against continuous exposure to intense light.

6.3 ESD Protection

Anti-ESD measures should be taken for this camera module in the same manner as semiconductor devices.

- (1) Either handle bare handed or use non-chargeable gloves, cloth or material. Also use conductive shoes.
- (2) When handling directly use a wrist strap.
- (3) Install grounded conductive mats on the floor and working table to prevent the generation of static electricity.
- (4) Discharge using ionized air or other means is recommended when handling this camera module.

6.4 Storage and Operating Environment

Avoid storage or use under high temperature, high humidity and dusty conditions.

6.5 Mechanical Strength

This camera module is a precision optical part, so care should be taken not to apply excessive mechanical shock or force.

6.6 Remodeling

Any remodeling or process at customers should be avoided. No product warranty will be granted if the product is once remodeled or processed.



6.7 EEPROM

The data in the EEPROM should not be modified or overwritten. Once they are modified or overwritten, no product warranty may be able to be given.

6.8 White Pixels

The image-sensing device is vulnerable to natural radiation such as cosmic radiation that may cause incidental defect resulting in white pixel. Although these white pixels are corrected during the final inspection and adjustment process of the camera module production, a minor number of the product might be affected during the storage and shipment, and "white pixel" may appear on incoming stage at customer production site. As the occurrence of white pixels is due to natural behavior, it's beyond supplier's control.

6.9 Vertical line noise in low light condition

Rarely a vertical line noise may happen in the case when a gain sets up in the low light condition. It's not a malfunction but the characteristic of CMOS Image Sensor

6.10 Safety Standards

This product is manufactured as an unfinished product and no particular safety standard is applicable to this product alone. Users should ensure that finished products using this camera module conform to applicable safety standards.

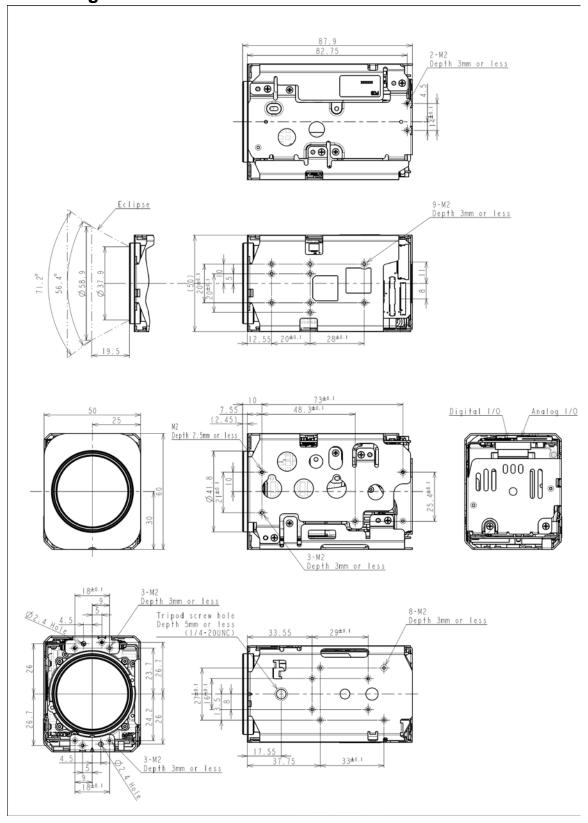
6.11 Location of Use and Storage

Do not shoot extremely bright objects (lights or sun) for long hours. In addition, please refrain from using or storing at the following locations.

- Extremely hot or cold place (Operating temperature: -5°C to +60°C(23°F to 140°F))
- Near TV/radio station which produces intense radio emission
- The place where is affected by reflects of fluorescent light or light from windows
- Under unstable illumination (Flickers will be generated)
- Place with intense vibration
- Where it is subject to radiation from laser beams



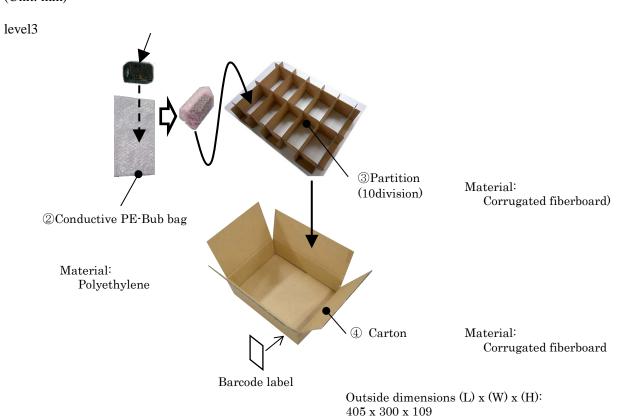
7 Package Outline





8 Package Specification

(Unit: mm)





Revision History

Version	Date 20/May/2014	Page	Description
0.10	20/May/2014	-	released.